

## High Voltage High Side Current and Voltage Sense

## **FEATURES**

#### **Current Sense**

Supply Range: 5V to 100V

■ Low Offset Voltage: ±500µV (Maximum)

1us Response Time

Gain Configurable with 2 Resistors

Low Input Bias Current: 170nA (Maximum)

PSRR: 118dB (Minimum)Low Supply Current: 250µA

#### **Voltage Sense**

Voltage Sense Range: 0V to 100VPrecision 1MΩ Resistor Divider

Low Total Gain Error: ±0.15% (Maximum)

Supply Voltage Range: 2.7V to 5.5V

Low Supply Current: 57μA

Operating Temperature Range: –40°C to 125°C

AEC-Q100 Qualified for Automotive Applications

## **APPLICATIONS**

Current Shunt Measurement

Battery Monitoring

Power Management

Automotive Sensing and Control

Industrial Monitoring

### DESCRIPTION

The LTC®6115 is a versatile combination of a high voltage, high side current sense amplifier and a voltage sense amplifier. Design flexibility is provided by the excellent device characteristics:  $\pm 500 \mu V$  maximum offset voltage for current sense and maximum  $\pm 0.15\%$  voltage sense total gain error.

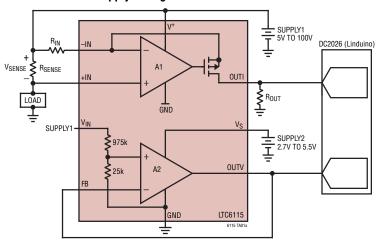
The current sensing part of the LTC6115 monitors current by sensing the voltage across an external sense resistor. The sensed voltage is converted to an output current which can then be translated to a voltage by an external resistor,  $R_{OUT}$ . Due to its fast response, it is a perfect choice for load current warning and shut-off protection control.

The LTC6115 also includes an internal  $1M\Omega$  resistor divider and a precision voltage amplifier for accurate voltage monitoring. The resistor attenuation of 40 enables sensing of up to 100V on the  $V_{IN}$  pin, making it suitable for precision high voltage monitoring in telecommunications, industrial and automotive applications. The full-scale output voltage can be configured by external gain resistors to maximize use of the amplifier's rail-to-rail output. The LTC6115 is available in a 12-lead MSOP package.

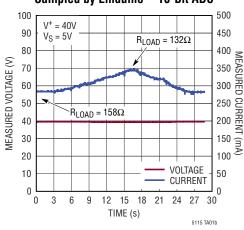
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## TYPICAL APPLICATION

#### **Power Supply Voltage and Load Current Monitor**



#### Voltage and Current Across Swept R<sub>LOAD</sub>, Sampled by Linduino™ 10-Bit ADC



Rev. B

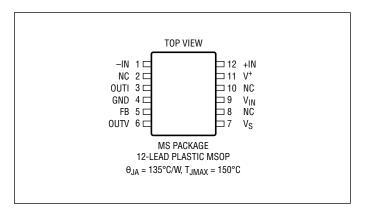
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## **ABSOLUTE MAXIMUM RATINGS**

#### (Note 1)

Total Supply Voltage
V <sup>+</sup> to GND105V
V <sub>S</sub> to GND6V
Input Voltage (V <sub>IN</sub> Pin)105V
Minimum –IN Pin Voltage(V+ – 4V)
FB Pin VoltageGND $- 0.3V$ to $V_S + 0.3V$
Input Current (+IN, -IN, FB Pins)±10mA
Maximum Output Voltage (OUTI Pin)9V
Output Short-Circuit Duration (to GND) Indefinite
Operating Temperature Range (Note 2)
LTC6115I40°C to 85°C
LTC6115H40°C to 125°C
Specified Temperature Range (Note 3)
LTC6115I40°C to 85°C
LTC6115H40°C to 125°C
Storage Temperature Range65°C to 150°C
Lead Temperature (Soldering, 10 sec)300°C

## PIN CONFIGURATION



## ORDER INFORMATION

TUBE	TAPE AND REEL	PART MARKING	PACKAGE DESCRIPTION	TEMPERATURE RANGE
LTC6115IMS#PBF	LTC6115IMS#TRPBF	6115	12-Lead Plastic MSOP	-40°C to 85°C
LTC6115HMS#PBF	LTC6115HMS#TRPBF	F 6115 12-Lead Plastic MSOP -40°C to 125°C		-40°C to 125°C
AUTOMOTIVE PRODUCTS*	*			
LTC6115HMS#WPBF	LTC6115HMS#WTRPBF	6115	12-Lead Plastic MSOP	-40°C to 125°C

Consult ADI Marketing for parts specified with wider operating temperature ranges.

Tape and reel specifications. Some packages are available in 500 unit reels through designated sales channels with #TRMPBF suffix.

# **ELECTRICAL CHARACTERISTICS** The $\bullet$ denotes the specifications which apply over the full specified temperature range, otherwise specifications are at $T_A = 25^{\circ}C$ . $R_{IN} = 100\Omega$ , $R_{OUT} = 10k\Omega$ , $V_{SENSE}^{+} = V^{+}$ (Note 4), $5V \le V^{+} \le 100V$ , $V_{IN} = 20V$ , unless otherwise noted.

SYMBOL	PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
CURRENT S	SENSE						
	Supply Voltage Range (V+)		•	5		100	V
V <sub>OS</sub>	Input Offset Voltage (+IN, -IN)	V <sub>SENSE</sub> = 5mV, Gain = 100	•		±85	±500 ±800	μV μV
$\Delta V_{OS}/\Delta T$	Input Offset Voltage Drift	V <sub>SENSE</sub> = 5mV, Gain = 100	•		±3		μV/°C
I <sub>B</sub>	Input Bias Current (+IN, -IN)	$R_{IN} = 1M\Omega, R_{OUT} = 1M\Omega$	•		85	170 245	nA nA
I <sub>OS</sub>	Input Offset Current	$R_{IN} = 1M\Omega$	•		±2	±20	nA
							Pay B

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<sup>\*\*</sup>Versions of this part are available with controlled manufacturing to support the quality and reliability requirements of automotive applications. These models are designated with a #W suffix. Only the automotive grade products shown are available for use in automotive applications. Contact your local Analog Devices account representative for specific product ordering information and to obtain the specific Automotive Reliability reports for these models.

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SYMBOL	PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
V <sub>SENSE(MAX)</sub>	Input Sense Voltage Full-Scale	Error < 1%, $R_{IN} = 1k\Omega$ (Note 5)	•	500			mV
PSRR	Power Supply Rejection Ratio (V+)	V <sup>+</sup> = 6V to 100V, V <sub>SENSE</sub> = 5mV, Gain = 100 Measured at OUTI	•	118 115	140		dB dB
		V <sup>+</sup> = 5V to 100V, V <sub>SENSE</sub> = 5mV, Gain = 100 Measured at OUTI	•	110 105	133		dB dB
V <sub>OUTI(MAX)</sub>	Maximum Output Voltage (OUTI)	$ \begin{array}{l} 12V \leq V^{+} \leq & 100V, \ V_{SENSE} = 88mV \\ V+ = & 5V, \ V_{SENSE} = 330mV, \ R_{IN} = & 1k\Omega, \ R_{OUT} = & 10k\Omega \end{array} $	•	8 3			V
V <sub>OUTI(MIN)</sub>	Minimum Output Voltage (OUTI)	V <sub>SENSE</sub> = 0V, Gain = 100 (Note 6)	•		0	50 80	mV mV
I <sub>OUTI</sub>	Maximum Output Current (OUTI)	$5V \le V^+ \le 100V$ , $R_{OUT} = 2k\Omega$ , $V_{SENSE} = 110mV$ , Gain = 20	•	1			mA
t <sub>r</sub>	Input Step Response (to 2.5V on a 5V Output Step)	$\Delta V_{SENSE}$ = 100mV Transient, 6V $\leq$ V <sup>+</sup> $\leq$ 100V, Gain = 50 V <sup>+</sup> = 5V. Measured at OUTI			1 1.5		μs μs
BW	Signal Bandwidth (OUTI)	$I_{OUTI}$ = 200μA, $R_{IN}$ = 100Ω, $R_{OUT}$ = 5kΩ $I_{OUTI}$ = 1mA, $R_{IN}$ = 100Ω, $R_{OUT}$ = 5kΩ			140 200		kHz kHz
I <sub>V</sub> +	Supply Current (V <sup>+</sup> )	$V^{+} = 5V$ , $I_{10UT} = 0$ , $R_{1N} = 1M\Omega$	•		240	450 475	μA μA
		$V^{+} = 6V, I_{10UT} = 0, R_{1N} = 1M\Omega$	•		250	475 525	μA μA
		$V^{+} = 12V$ , $I_{1OUT} = 0$ , $R_{1N} = 1M\Omega$	•		260	500 590	μA μA
		$V^{+} = 100V$ , $I_{10UT} = 0$ , $R_{1N} = 1M\Omega$	•		400	640 720	μA μA
<b>VOLTAGE SE</b>	NSE, V <sub>S</sub> = 3V						
	Supply Voltage Range (V <sub>S</sub> )	Guaranteed by the PSRR Test	•	2.7		5.5	V
	V <sub>IN</sub> Voltage Range	Referred to GND		0		60	٧
ΔG	Total Gain Error at V <sub>IN</sub> = 60V	No Load	•		0.04	±0.15	%
ΔG	Total Gain Error at V <sub>IN</sub> = 5V	No Load	•		0.04	±0.20 ±0.24	% %
	Input Resistor Value	Measured from V <sub>IN</sub> to GND	•	0.85	1	1.15	MΩ
e <sub>nP-P</sub>	Input Noise Voltage (V <sub>IN</sub> )	0.1Hz to 10Hz, V <sub>IN</sub> Referred, V <sub>IN</sub> = 15V, A <sub>V</sub> = 1			60		μV <sub>P-P</sub>
e <sub>n</sub>	Input Noise Voltage Density (V <sub>IN</sub> ) (Note 7)	f = 1kHz f = 10kHz			1.26 1.13		μV/√Hz μV/√Hz
i <sub>n</sub>	Input Noise Current Density (Note 8)				1		fA/√Hz
PSRR	Power Supply Rejection Ratio (V <sub>S</sub> )	$V_S$ = 2.7V to 5.5V, $V_{IN}$ = 20V. Measured at OUTV	•	95	115		dB
$V_{OH}$	Output Voltage, High (V <sub>S</sub> – OUTV)	No Load  SOURCE = 0.2mA  SOURCE = 2mA	•		1	2 30 300	mV mV mV
$V_{0L}$	Output Voltage, Low (OUTV – GND)	No Load  SINK = 0.2mA  SINK = 2mA	•		1	2 25 220	mV mV mV
I <sub>SC</sub>	Output Short-Circuit Current (OUTV)	Source	•	9 6.5	12		mA mA
		Sink	•	8 6	13		mA mA
GBW	Gain-Bandwidth Product (OUTV) (f <sub>TEST</sub> = 20kHz)	R <sub>L</sub> = 100k	•	300 270	530		kHz

**ELECTRICAL CHARACTERISTICS** The  $\bullet$  denotes the specifications which apply over the full specified temperature range, otherwise specifications are at  $T_A = 25^{\circ}C$ .  $R_{IN} = 100\Omega$ ,  $R_{OUT} = 10k\Omega$ ,  $V_{SENSE}^{+} = V^{+}$  (Note 4),  $5V \le V^{+} \le 100V$ ,  $V_{IN} = 20V$ , unless otherwise noted.

SYMBOL	PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
$\overline{t_S}$	Settling Time 0.1%	A <sub>V</sub> = 1, 1V Output Step			25		μs
Is	Amplifier Supply Current (V <sub>S</sub> )	No Load, V <sub>IN</sub> = 20V	•		55	76 85	μA μA
VOLTAGE SE	ENSE, V <sub>S</sub> = 5V						
	Supply Voltage Range (V <sub>S</sub> )	Guaranteed by the PSRR Test	•	2.7		5.5	V
	V <sub>IN</sub> Voltage Range	Referred to GND		0		100	V
ΔG	Total Gain Error at V <sub>IN</sub> = 100V	No Load	•		0.03	±0.15	%
ΔG	Total Gain Error at V <sub>IN</sub> = 5V	No Load	•		0.03	±0.20 ±0.24	% %
	Input Resistor Value	Measured from V <sub>IN</sub> to GND	•	0.85	1	1.15	MΩ
I <sub>B</sub> (FB Pin)	Input Bias Current	V <sub>IN</sub> = 100V -40°C to 85°C -40°C to 125°C	•		3	100 300 2000	pA pA pA
e <sub>nP-P</sub>	Input Noise Voltage	0.1Hz to 10Hz, $V_{IN}$ Referred, $V_{IN} = 15V$ , $A_V = 1$			60		μV <sub>P-P</sub>
e <sub>n</sub>	Input Noise Voltage Density (V <sub>IN</sub> ) (Note 7)	f = 1kHz f = 10kHz			1.26 1.13		μV/√Hz μV/√Hz
i <sub>n</sub>	Input Noise Current Density (Note 8)				1		fA/√Hz
PSRR	Power Supply Rejection Ratio (V <sub>S</sub> )	$V_S = 2.7V$ to 5.5V, $V_{IN} = 20V$ , Measured at OUTV	•	95	115		dB
V <sub>OH</sub>	Output Voltage, High (V <sub>S</sub> – OUTV)	No Load I <sub>SOURCE</sub> = 0.5mA I <sub>SOURCE</sub> = 5mA	•		1	2 45 450	mV mV mV
$V_{0L}$	Output Voltage, Low (OUTV - GND)	No Load   I <sub>SINK</sub> = 0.5mA   I <sub>SINK</sub> = 5mA	•		1	2 35 350	mV mV mV
I <sub>SC</sub>	Output Short-Circuit Current (OUTV)	Source	•	18 17	27		mA mA
		Sink	•	16 14	27		mA mA
SR	Slew Rate	A <sub>V</sub> = 1	•	0.035	0.06		V/µs
GBW	Gain-Bandwidth Product (OUTV) (f <sub>TEST</sub> = 20kHz)	$R_L = 100k\Omega$	•	300 270	530		kHz
t <sub>S</sub>	Settling Time 0.1%	A <sub>V</sub> = 1, 1V Output Step			25		μs
I <sub>S</sub>	Amplifier Supply Current (V <sub>S</sub> )	No Load, V <sub>IN</sub> = 20V	•		57	76 85	μA μA

**Note 1:** Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.

**Note 2:** The LTC6115I is guaranteed functional over the operating temperature range of -40°C to 85°C. The LTC6115H is guaranteed functional over the operating temperature range of -40°C to 125°C.

**Note 3:** The LTC6115I is guaranteed to meet specified performance from -40°C to 85°C. The LTC6115H is guaranteed to meet specified performance from -40°C to 125°C.

**Note 4:**  $V_{SENSE}$  is the voltage developed across the external sense resistor  $R_{SENSE}$ .  $V_{SENSE}^+$  is the voltage at the high side of  $R_{SENSE}$ . See the Typical Application drawing on the front page.

Note 5:  $R_{OUT} = 10k\Omega$  for  $7V \le V_S \le 100V$ ,  $R_{OUT} = 2k\Omega$  for  $V_S = 5V$ , 6V.

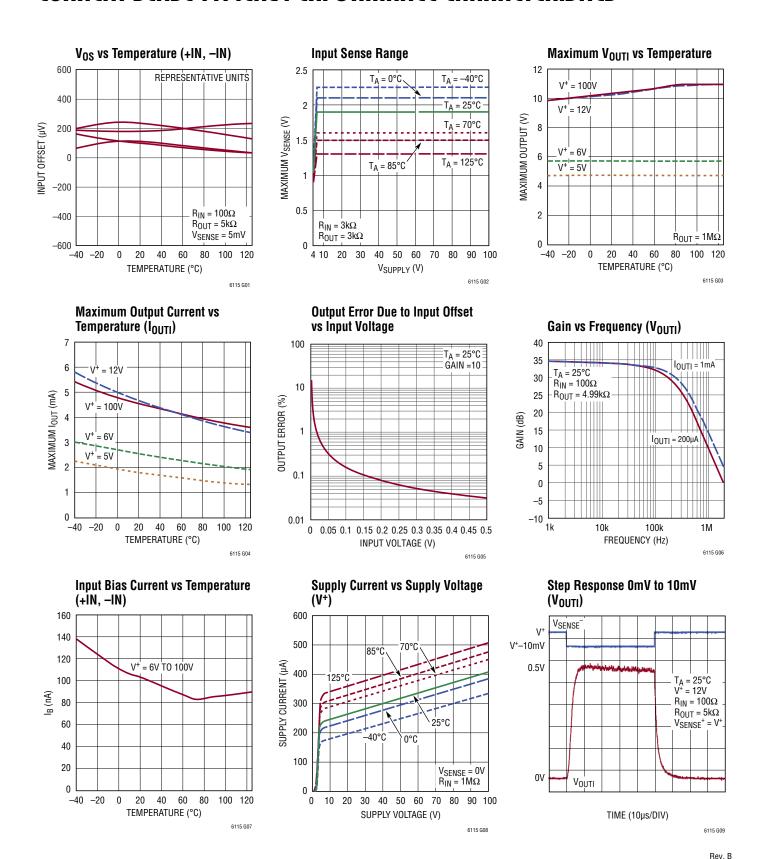
**Note 6:** Current sense minimum output voltage is measured with 0V shunt voltage and is limited by the maximum positive offset voltage.

**Note 7:** This includes the noise of the resistor divider and amplifier A2, referred to the  $V_{\text{IN}}$  pin. See the section on Noise Sources under Applications Information: Voltage Sense for more details.

Note 8: Current noise is calculated from:

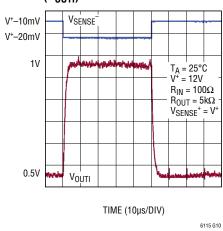
$$i_n = \sqrt{2qI_B}$$
, where  $q = 1.6 \cdot 10^{-19}$  Coulombs.

## **CURRENT SENSE TYPICAL PERFORMANCE CHARACTERISTICS**

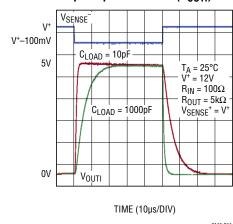


## **CURRENT SENSE TYPICAL PERFORMANCE CHARACTERISTICS**

#### Step Response 10mV to 20mV $(V_{OUTI})$



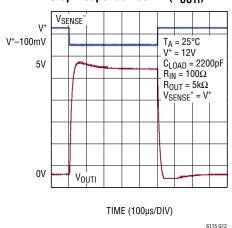
#### Step Response 100mV (V<sub>OUTI</sub>)



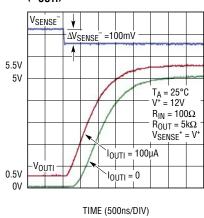
6115 G11

6115 G13

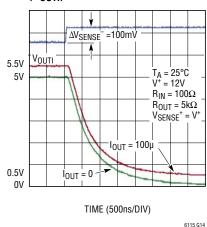
## Step Response 100mV (V<sub>OUTI</sub>)



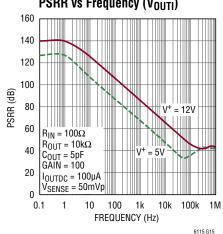
#### Step Response Rising Edge $(V_{OUTI})$



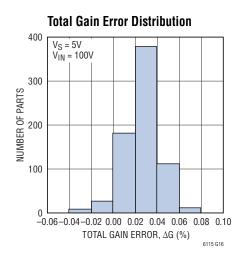
Step Response Falling Edge  $(V_{OUTI})$ 

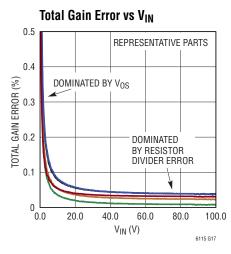


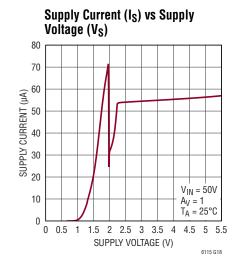
#### PSRR vs Frequency (Vouti)

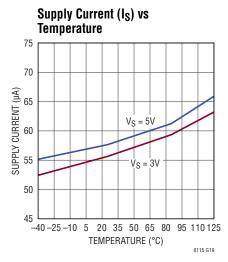


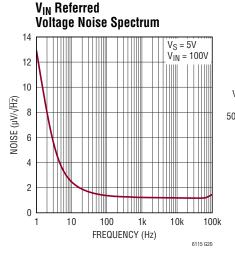
## **VOLTAGE SENSE TYPICAL PERFORMANCE CHARACTERISTICS**

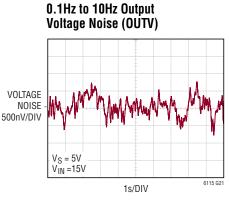


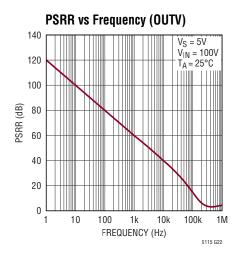


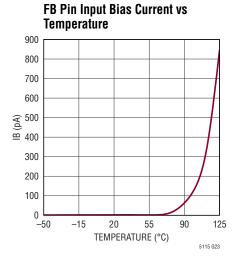


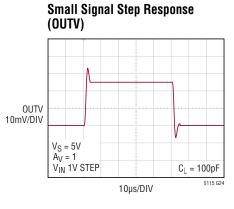






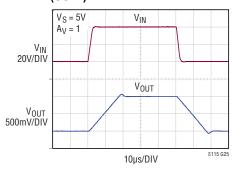




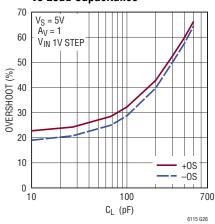


## **VOLTAGE SENSE TYPICAL PERFORMANCE CHARACTERISTICS**

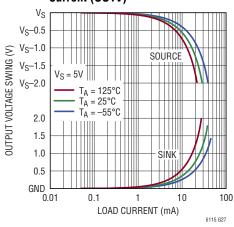
Step Response 20V to 40V (OUTV)



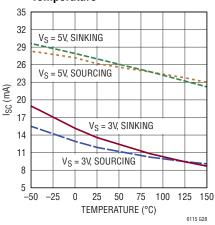
Small Signal Overshoot (OUTV) vs Load Capacitance



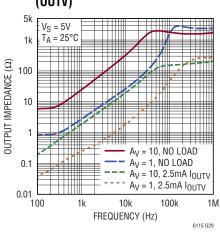
Output Voltage Swing vs Load Current (OUTV)



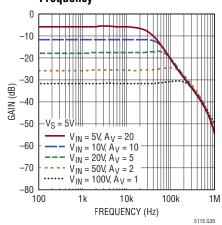
Short Circuit Current (OUTV) vs Temperature



Output Impedance vs Frequency (OUTV)



#### Through Gain (OUTV/V<sub>IN</sub>) vs Frequency



## PIN FUNCTIONS

**-IN (Pin 1):** Inverting Input of the Current Sense Amplifier. The internal current sense amplifier will drive —IN to the same potential as +IN.

**OUTI (Pin 3):** Current Output of Current Sense Amplifier. OUTI will source a current that is proportional to the sense voltage into an external resistor.

GND (Pin 4): Ground.

**FB(Pin 5):** Voltage Sense Amplifier Inverting Input.

OUTV (Pin 6): Voltage Sense Amplifier Output Voltage.

**+IN (Pin 12):** Noninverting Input of the Current Sense Amplifier. Must be tied to the system load end of the sense resistor, either directly or through a resistor.

**V**<sup>+</sup> (**Pin 11**): Positive Supply Pin for Current Sense Circuit. Supply current for the current sense circuit is drawn through this pin.

V<sub>IN</sub> (Pin 9): Voltage Sense Amplifier Input Voltage.

V<sub>S</sub> (Pin 7): Voltage Sense Amplifier Positive Supply.

NC (Pins 2, 8, 10): Not internally connected.

## **BLOCK DIAGRAM**

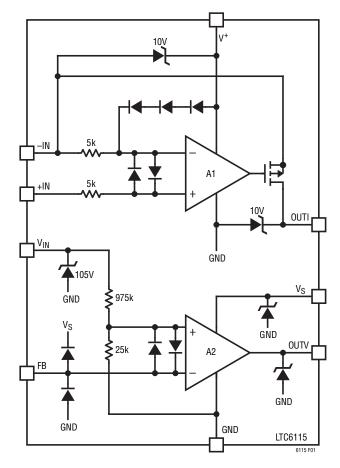


Figure 1. LTC6115 Block Diagram

The LTC6115 high side current sense amplifier (Figure 1, Amplifier A1) provides accurate monitoring of current through an external user-selected sense resistor. The sense voltage is amplified by a user-selected gain and level shifted from the positive power supply to a ground-referred output current. The output signal is analog and may be used as is or processed with an output filter.

#### **Theory of Operation**

An internal sense amplifier loop forces –IN to have the same potential as +IN. Connecting an external resistor,  $R_{\text{IN}}$ , between –IN and V+ forces a potential across  $R_{\text{IN}}$  that is the same as the sense voltage across  $R_{\text{SENSE}}$ . A corresponding current,  $V_{\text{SENSE}}/R_{\text{IN}}$ , will flow through  $R_{\text{IN}}$ . The high impedance inputs of the sense amplifier will not conduct this input current, so it will flow through the internal MOSFET to the output pin.

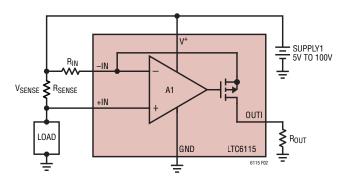


Figure 2.

The output current can be transformed into a voltage by adding a resistor from OUTI to GND. The output voltage is then  $V_{OUTI} = I_{OUTI} \cdot R_{OUTI}$ .

Table 1. Useful Gain Configurations

GAIN	R <sub>IN</sub> (Ω)	R <sub>OUT</sub> (Ω)	V <sub>SENSE</sub> AT V <sub>OUT</sub> = 5V	I <sub>OUT</sub> AT V <sub>OUT</sub> = 5V
20	499	10k	250mV	500μΑ
50	200	10k	100mV	500μΑ
100	100	10k	50mV	500μΑ

#### Selection of External Current Sense Resistor

The external sense resistor, R<sub>SENSE</sub>, has a significant effect on the function of a current sensing system and must be chosen with care.

First, the power dissipation in the resistor should be considered. The system load current will cause both heat and voltage drop in R<sub>SENSE</sub>. As a result, the sense resistor should be as small as possible while still providing the input dynamic range required by the measurement. Note that input dynamic range is the difference between the maximum input signal and the minimum accurately reproduced signal, and is limited primarily by input DC offset of the internal current sense amplifier. In addition, R<sub>SENSE</sub> must be small enough that V<sub>SENSE</sub> does not exceed the maximum  $V_{SENSE}$  input voltage specified by the LTC6115 current sense amplifier, even under peak load conditions. As an example, an application may require that the maximum sense voltage be 100mV. If this application is expected to draw 2A at peak load, R<sub>SENSE</sub> should be no more than  $50m\Omega$ .

Once the maximum  $R_{SENSE}$  value is determined, the minimum sense resistor value will be set by the resolution or dynamic range required. The minimum signal that can be accurately represented by this sense amp is limited by the input offset. As an example, the LTC6115 current sense amplifier has a typical input offset of  $85\mu V$ . If the minimum current is 20mA, a sense resistor of  $5m\Omega$  will set  $V_{SENSE}$  to  $100\mu V$ . This is only slightly higher than the input offset. A larger sense resistor will reduce the error due to offset by increasing the sense voltage for a given load current.

Choosing a  $50m\Omega$  R<sub>SENSE</sub> will maximize the dynamic range and provide a system that has 100mV across the sense resistor at peak load (2A), while an input offset of  $85\mu V$  causes an error equivalent to only 1.7mA of load current. Peak power dissipation in the sense resistor will be 200mW. If a  $5m\Omega$  sense resistor is employed, then the effective current error is 17mA, while the peak sense voltage is reduced to 10mV at 2A, dissipating only 20mW.

The low offset and corresponding large dynamic range of the LTC6115 make it more flexible than other solutions in this respect. The 85µV typical offset gives 60dB of dynamic range for a sense voltage that is limited to 85mV maximum, and over 75dB of dynamic range if the rated input maximum of 500mV is allowed.

#### **Sense Resistor Connection**

Kelvin connection of the -IN and +IN inputs to the sense resistor should be used in all but the lowest power applications. Solder connections and PC board interconnections that carry high current can cause significant error in measurement due to their relatively large resistances. One  $10\text{mm} \times 10\text{mm}$  square trace of one-ounce copper is approximately  $0.5\text{m}\Omega$ . A 1mV error can be caused by as little as 2A flowing through this small interconnect. This will cause a 1% error in a 100mV signal. A 10A load current in the same interconnect will cause a 5% error for the same 100mV signal. By isolating the sense traces from the high current paths, this error can be reduced by orders of magnitude. A sense resistor with integrated Kelvin sense terminals will give the best results. Figure 3 illustrates the recommended method.

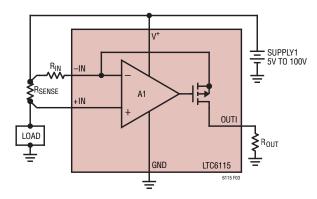


Figure 3. Kelvin Input Connection Preserves Accuracy Despite Large Load Current

### Selection of External Input Resistor, RIN

The external input resistor,  $R_{IN}$ , controls the transconductance of the current sense circuit. Since  $I_{OUTI} = V_{SENSE}/R_{IN}$ , transconductance  $g_m = 1/R_{IN}$ . For example, if  $R_{IN} = 100$ , then  $I_{OUTI} = V_{SENSE}/100$ , or  $I_{OUTI} = 1mA$  for  $V_{SENSE} = 100mV$ .

 $R_{IN}$  should be chosen to allow the required resolution while limiting the output current.  $I_{OUTI}$  may be as much as 1mA. By setting  $R_{IN}$  such that the largest expected sense voltage gives  $I_{OUTI} = 1$ mA, then the maximum output dynamic range is available. Output dynamic range is limited by both the maximum allowed output current and the maximum allowed output voltage, as well as the

minimum practical output signal. If less dynamic range is required, then  $R_{\text{IN}}$  can be increased accordingly, reducing the maximum output current and power dissipation.

If low sense currents must be resolved accurately in a system that has very wide dynamic range, a larger  $R_{SENSE}$  may be used if the maximum current is limited in another way, such as with a Schottky diode across  $R_{SENSE}$  (Figure 4). This will reduce the high current measurement accuracy by limiting the result, while increasing the low current measurement resolution.

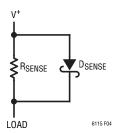


Figure 4. Shunt Diode Limits Maximum Input Voltage to Allow Better Low Input Resolution Without Overranging

This approach can be helpful in cases where occasional large burst currents may be ignored.

Care should be taken when designing the board layout for  $R_{IN}$ , especially for small  $R_{IN}$  values. All trace and interconnect impedances will increase the effective  $R_{IN}$  value, causing a gain error. In addition, internal device resistance will add approximately  $0.2\Omega$  to  $R_{IN}$ .

## Selection of External Output Resistor, $R_{OUT}$

The output resistor,  $R_{OUT}$ , determines how the output current is converted to voltage.  $V_{(OUTI)}$  is simply  $I_{(OUTI)}$  •  $R_{OUT}$ .

In choosing an output resistor, the maximum output voltage must first be considered. If the circuit that is driven by the output does not limit the output voltage, then  $R_{OUT}$  must be chosen such that the maximum output voltage does not exceed the LTC6115  $I_{OUT}$  maximum output voltage rating. If the following circuit is a buffer or ADC with limited input range, then  $R_{OUT}$  must be chosen so that  $I_{OUTI(MAX)} \bullet R_{OUT}$  is less than the allowed maximum input range of this circuit.

In addition, the output impedance is determined by  $R_{OUT}$ . If the circuit to be driven has high enough input impedance, then almost any useful output impedance will be acceptable. However, if the driven circuit has relatively low input impedance, or draws spikes of current, such as an ADC might do, then a lower  $R_{OUT}$  value may be required in order to preserve the accuracy of the output. As an example, if the input impedance of the driven circuit is 100 times  $R_{OUT}$ , then the accuracy of  $V_{OUT}$  will be reduced by 1% since:

$$V_{OUTI} = I_{OUTI} \bullet \frac{R_{OUT} \bullet R_{IN(DRIVEN)}}{R_{OUT} + R_{IN(DRIVEN)}}$$
$$= I_{OUTI} \bullet R_{OUT} \bullet \frac{100}{101}$$
$$= 0.99 \bullet I_{OUTI} \bullet R_{OUT}$$

#### **Error Sources**

The current sense circuit uses an amplifier and resistors to apply gain and level shift the result. The output is then dependent on the characteristics of the amplifier, such as gain and input offset, as well as resistor matching.

Ideally the circuit output is:

$$V_{OUTI} = V_{SENSE} \cdot \frac{R_{OUT}}{R_{IN}}$$

$$V_{SENSE} = R_{SENSE} \cdot I_{SENSE}$$

In this case, the only error is due to resistor mismatch, which provides an error in gain only. However, offset voltage, bias current and finite gain in the amplifier cause additional errors.

## Output Error, $E_{OUTI(VOS)}$ , Due to the Amplifier DC Offset Voltage, $V_{OS}$

$$E_{OUTI(VOS)} = V_{OS} \bullet (R_{OUT}/R_{IN})$$

The DC offset voltage of the amplifier adds directly to the value of the sense voltage,  $V_{SENSE}$ . This is the dominant error of the system and it limits the available dynamic range. The section Selection of External Current Sense Resistor provides details.

## Output Error, $E_{OUTI(IBIAS)}$ , Due to the Bias Currents, $I_B^+$ and $I_B^-$

The bias current  $I_{B+}$  flows into the positive input of the internal op amp.  $I_{B-}$  flows into the negative input.

$$\begin{split} E_{OUTI(IBIAS)} &= R_{OUT}((I_B + \bullet (R_{SENSE}/R_{IN})) - I_B -) \\ \text{Since } I_B + \approx I_B - = I_{BIAS}, \text{ if } R_{SENSE} << R_{IN} \text{ then,} \\ E_{OUTI(IBIAS)} &\approx -R_{OUT} \bullet I_{BIAS} \end{split}$$

For instance if  $I_{BIAS}$  is 100nA and  $R_{OUT}$  is  $1k\Omega$ , the output error is 0.1mV.

Note that in applications where  $R_{SENSE} \approx R_{IN}, \ I_{B}+$  causes a voltage offset in  $R_{SENSE}$  that cancels the error due to  $I_{B}-$  and  $E_{OUTI(IBIAS)} \approx 0.$  In applications where  $R_{SENSE} < R_{IN}$ , the bias current error can be similarly reduced if an external resistor  $R_{IN}+=(R_{IN}--R_{SENSE})$  is connected as shown in Figure 5.

Under both conditions:

$$E_{OUTI(IBIAS)} = \pm R_{OUT} \bullet I_{OS}$$
$$I_{OS} = I_{B} + -I_{B} -$$

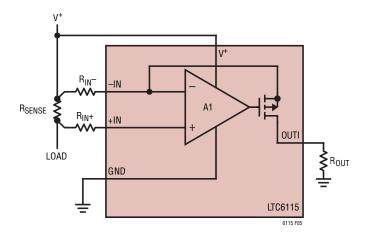


Figure 5. Second Input R Minimizes Error Due to Input Bias Current

If the offset current,  $I_{OS}$ , of the LTC6115 current sense amplifier is 2nA, the 100mV error above is reduced to 2mV. Adding  $R_{IN}$ + as described will maximize the dynamic range of the circuit. For less sensitive designs,  $R_{IN}$ + is not necessary.

#### **Example**

If a circuit has an expected  $I_{SENSE}$  range of 1A to 1mA, and  $(V_{OUTI}/I_{SENSE}) = 3V/1A$ , then, from the Electrical Characteristics of the LTC6115 current sense amplifier,  $R_{SENSE} \approx V_{SENSE(MAX)}/I_{SENSE(MAX)} = 500 \text{mV}/1A = 500 \text{m}\Omega$ .

Gain =  $R_{OUT}/R_{IN} = V_{OUTI(MAX)}/V_{SENSE(MAX)} = 3V/500mV = 6$ .

If the maximum output current, I<sub>OUTI</sub>, is limited to 1mA, R<sub>OUT</sub> equals 3V/1mA  $\approx$  3.01k $\Omega$  (1% value) and R<sub>IN</sub> = 3k $\Omega$ /6  $\approx$  499 $\Omega$  (1% value).

The output error due to DC offset is  $\pm 510\mu V$  (85 $\mu V$  typical • gain of 6) and the error due to offset current,  $I_{OS}$  is  $3k\Omega • \pm 2nA = \pm 6\mu V$  (typical), provided  $R_{IN}+=R_{IN}-$ .

The maximum output error can therefore reach  $\pm 516\mu V$  or 0.017% (-75dB) of the output full-scale. Considering the system input 60dB dynamic range ( $I_{SENSE} = 1mA$  to 1A), the 70dB performance of the LTC6115 current sense amplifier makes this application feasible.

## Output Error, $E_{OUT}$ , Due to the Finite DC Open-Loop Gain, $A_{OL}$ , of the LTC6115 Current Sense Amplifier

This error is inconsequential as the  $A_{OL}$  of the amplifier is very large.

## **Output Current Limitations Due to Power Dissipation**

The current sense amplifier can deliver up to 1mA continuous current to the output pin. This current flows through  $R_{\text{IN}}$  and enters the current sense amplifier via the –IN pin. The power dissipated in the current sense circuit due to the output signal is:

$$\begin{split} P_{OUTI} &= (V_{-IN} - V_{OUTI}) \bullet I_{OUTI} \\ \text{Since } V_{-IN} \approx V^+, \, P_{OUTI} \approx (V^+ - V_{OUTI}) \bullet I_{OUTI} \end{split}$$

There is also power dissipated due to the quiescent supply current:

$$P_Q = I_V + \bullet V^+$$

The total power dissipated is the output dissipation plus the quiescent dissipation:

$$P_{TOTAL} = P_{OUTI} + P_{Q}$$

At maximum supply and maximum output current, the total power dissipation can exceed 100mW. This will cause significant heating of the die. In order to prevent damage to the circuit, the maximum expected dissipation in each application should be calculated. This number can be multiplied by the  $\theta_{JA}$  value listed in the Pin Configuration section to find the maximum expected die temperature. This must not be allowed to exceed 150°C, or performance may be degraded.

As an example, if only the current sense is to run at 100V supply voltage on V<sup>+</sup>, with 1mA output current at 125°C:

$$P_{Q(MAX)} = I_{V}^{+}(MAX) \cdot V^{+}(MAX)$$
 $= 720\mu A \cdot 100V$ 
 $= 72mW$ 
 $P_{OUT(MAX)} = I_{OUTI} \cdot V^{+}(MAX)$ 
 $= 1mA \cdot 100V$ 
 $= 100mW$ 
 $T_{RISE} = \theta_{JA} \cdot P_{TOTAL(MAX)}$ 
 $= 135^{\circ}C/W \cdot 172mW$ 
 $= 23.2^{\circ}C$ 
 $T_{MAX} = T_{AMBIENT} + T_{RISE}$ 
 $= 125^{\circ}C + 23.2^{\circ}C$ 
 $= 148.2^{\circ}C$ 

The junction temperature will thus be very close to 150°C, above the specified temperature range. In this case, the maximum output current should be reduced, which can be done by changing  $R_{\rm IN}$ .

It is important to note that the current sense amplifier has been designed to provide at least 1mA to the output when required, and can deliver more depending on the conditions. Care must be taken to limit the maximum output current by proper choice of sense resistor and, if input fault conditions exist, external clamps.

### **Output Filtering**

The output voltage at pin OUTI is simply  $I_{OUTI} \cdot Z_{OUTI}$ . This makes filtering straightforward. Any circuit may be used which generates the required  $Z_{OUTI}$  to get the desired filter response. For example, a capacitor in parallel with  $R_{OUT}$  will give a low pass response. This will reduce unwanted noise from the output, and may also be useful as a charge reservoir to keep the output steady while driving a switching circuit such as a multiplexer or ADC. This output capacitor in parallel with an output resistor will create a pole in the output response at:

$$f_{-3dB} = \frac{1}{2 \cdot \pi \cdot R_{OUT} \cdot C_{OUT}}$$

#### **Useful Equations**

Input Voltage: V<sub>SENSE</sub> = I<sub>SENSE</sub> • R<sub>SENSE</sub>

Voltage Gain:  $\frac{V_{OUTI}}{V_{SENSE}} = \frac{R_{OUT}}{R_{IN}}$ 

Current Gain:  $\frac{I_{OUTI}}{I_{SENSE}} = \frac{R_{SENSE}}{R_{IN}}$ 

Transconductance:  $\frac{I_{OUT}}{V_{SENSE}} = \frac{1}{R_{IN}}$ 

Transimpedance:  $\frac{V_{OUT}}{I_{SENSE}} = R_{SENSE} \cdot \frac{R_{OUT}}{R_{IN}}$ 

## Input Common Mode Range

The inputs of the current sense amplifier can function from 1.5V below  $V^+$  to 0.5V above it. Not only does this allow a wide  $V_{SENSE}$  range, it allows the input reference to be separate from the positive supply (Figure 6).

If the maximum  $V_{SENSE}$  is less than  $V_{SENSE(MAX)}$  (500mV as shown in the Electrical Characteristics table), the current sense amplifier may monitor its own supply current, as well as that of the load (Figure 7).

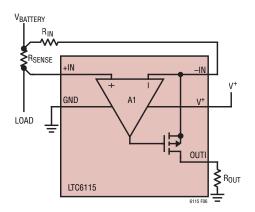


Figure 6. V+ Powered Separately from Load Supply (VBATTERY)

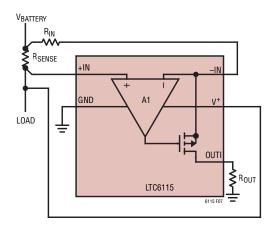


Figure 7. Current Sense Amplifier Supply Current Monitored with Load

### **Response Time**

The current sense amplifier is designed to exhibit fast response to inputs for the purpose of circuit protection or signal transmission. The response time will however also be affected by the external circuit.

If the output current is very low and an input transient occurs, there may be an increased delay before the output voltage begins changing. This can be improved by increasing the minimum output current, either by increasing  $R_{\text{SENSE}}$  or decreasing  $R_{\text{IN}}.$  The effect of increased output current is illustrated in the step response curves in the Current Sense Typical Performance Characteristics section of this data sheet. Note that the curves are labeled with respect to the initial output currents.

If the input changes very quickly, the internal amplifier will slew the gate of the internal output FET (Figure 1) in order to maintain the internal loop. This results in current flowing through  $R_{\text{IN}}$  and the internal FET. This current slew rate will be determined by the amplifier and FET characteristics as well as the input resistor,  $R_{\text{IN}}$ . Using a smaller  $R_{\text{IN}}$  will allow the output current to increase more quickly,

decreasing the response time at the output. This will also have the effect of increasing the maximum output current. Using a larger  $R_{OUT}$  will decrease the response time, since  $V_{OUTI} = I_{OUTI} \bullet R_{OUT}$ . Reducing  $R_{IN}$  and increasing  $R_{OUT}$  will have the effect of increasing the voltage gain of the circuit.

## APPLICATIONS INFORMATION: VOLTAGE SENSE

The voltage sense amplifier provides accurate monitoring of a voltage up to 100V. The input voltage is internally divided down by 40 by a  $1M\Omega$  precision resistor divider and the low offset of the amplifier enables accurate buffering of the attenuated voltage. The amplifier can also be put in an appropriate gain in the feedback path to allow full use of the rail-to-rail output of the op amp, when a lower voltage is being monitored on the  $V_{IN}$  pin.

The high impedance input resistor divider reduces the leakage concerns associated with large value resistors on a circuit board and the associated measurement errors.

#### **Input Voltage Range**

The maximum voltage that can accurately be monitored on the  $V_{IN}$  pin is limited by the supply voltage,  $V_S$ , as it affects the input common mode of the internal operational amplifier A2. The full 100V range on  $V_{IN}$  is available with a supply voltage of 4V or more. With a 3V supply, it is recommended to keep  $V_{IN}$  below 60V to maximize precision. Beyond these recommended  $V_{IN}$  voltages at each supply voltage, accuracy will degrade.

At lower  $V_{\text{IN}}$  voltages, external resistors can be used to add gain and maximize use of amplifier A2's rail-to-rail output (see Figure 8).

#### **Preserving Measurement Precision**

To maximize precision and make use of the 0.04% typical accuracy of the voltage sense circuit, errors added by the application circuit and the PC board layout should be minimized.

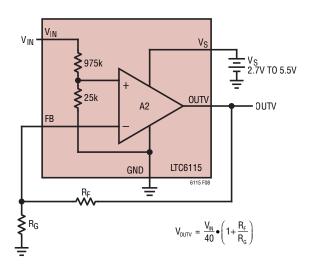


Figure 8. External Resistors to Add Gain

Temperature differentials across the input connections can generate thermocouple voltages of tens of microvolts so the connections to the input leads should be short, close together and away from heat dissipating components. Air current across the board can also generate temperature differentials.

The extremely low input bias current of the LTC6115 voltage sense amplifier FB pin allows accuracy to be maintained with high impedance feedback resistors as well.

#### **Input Clamps**

The voltage sense amplifier A2 has anti-parallel diodes between its inputs (Figure 1). The FB pin should not be forced more than a diode voltage away from its expected voltage ( $V_{IN}/40$ ), as this will forward bias a diode and a lot of current will then flow through the pin.

## APPLICATIONS INFORMATION: VOLTAGE SENSE

#### **Capacitive Load**

The voltage sense amplifier can drive capacitive load up to 100pF in unity gain. The capacitive load driving capability increases as the amplifier is used in higher gain configurations. A small resistance between the output and the load further increases the amount of capacitance the amplifier can drive.

#### **PC Board Layout**

Mechanical stress on a PC board and soldering-induced stress can cause offset shifts. A simple way to reduce the stress-related shift is to mount the IC near the short edge of the PC board, or in a corner. The board acts as a stress boundary, or a region where the flexure of the board is minimum. The package should always be mounted so that the leads absorb the stress and not the package. The package is generally aligned with the leads parallel to the long side of the PC board.

#### **Noise Sources**

Figure 9 shows all the noise contributors in a typical voltage-sense configuration, with optional gain-setting resistances  $R_{\text{F}}$  and  $R_{\text{G}}$ .

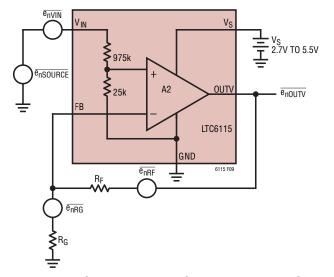


Figure 9. Noise Sources of Voltage Sense Amplifier in LTC6115

The total noise at the output can be calculated with:

$$\overline{e_{\text{n,OUTV}}} = \sqrt{\frac{\overline{e_{\text{n,VIN}^2}} + \overline{e_{\text{n,SOURCE}^2}}}{40^2}} \left(1 + \frac{R_{\text{F}}}{R_{\text{G}}}\right)^2 + \overline{e_{\text{n,RG}^2}} \frac{R_{\text{F}^2}}{R_{\text{G}^2}} + \overline{e_{\text{n,RF}^2}}$$

The individual sources of noise in this equation, as shown in Figure 9, are:

$$\overline{e_{\text{n,SOURCE}}}$$
   
   
Noise Added by Signal Source

$$\overline{e}_{n,RF} = \sqrt{4kTR_F}$$
 Thermal Noise of R<sub>F</sub>

$$\overline{e_{n,RG}}^{-} = \sqrt{4kTR_G}$$
 Thermal Noise of  $R_G$ 

 $\overline{e_{n,VIN}}$  accounts for all internal noise sources in A2 (including the 975k to 25k resistor divider and the amplifier), referred back to the  $V_{IN}$  input pin. This  $V_{IN}$  referred voltage noise density is shown in the typical curve  $V_{IN}$  Referred Voltage Noise Spectrum.

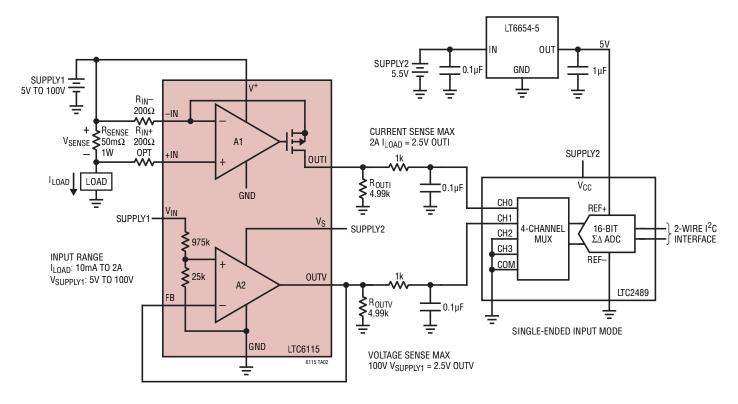
When calculating the total output noise, all voltage noise applied at  $V_{IN}$ , shown as  $\overline{e_{n,SOURCE}}$  in Figure 9, and  $\overline{e_{n,VIN}}$  is divided down by 40 due to the 975k to 25k resistor divider. Subsequently this noise is gained up by the non-inverting gain of the amplifier. Conversely,  $\overline{e_{n,OUTV}}$ , which accounts for all voltage noise at  $V_{OUT}$ , is first divided down by the external gain set by  $R_F$  and  $R_G$ , and then multiplied up by 40 to calculate  $V_{IN}$  noise. The plot 0.1Hz to 10Hz Output Voltage Noise (OUTV) depicts peak-to-peak voltage noise at the output, where it has not been referred to the input.

To optimize for lowest output noise, use values no larger than 55k to keep  $R_F$  and  $R_G$ 's thermal noise comparable to that contributed by the amplifier itself. The trade-off of lower  $R_F$  and  $R_G$  values is an increase of 10's of  $\mu A$  in power consumption in the feedback network, which may be significant in power-limited designs.

The input current noise density at the feedback pin FB of the voltage sense operational amplifier, A2, is on the order of  $1fA/\sqrt{Hz}$ . For most practical resistor values, the contribution of input current noise to the total output noise is negligible.

## TYPICAL APPLICATIONS

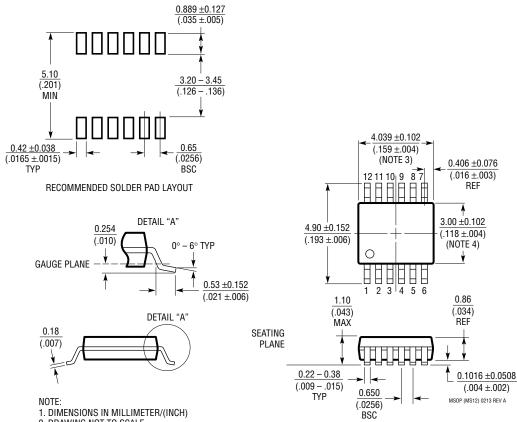
#### 16-Bit Current and Voltage Sensing with LTC6115



## PACKAGE DESCRIPTION

#### MS Package 12-Lead Plastic MSOP

(Reference LTC DWG # 05-08-1668 Rev A)



- 2. DRAWING NOT TO SCALE
- DIMENSION DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.
   MOLD FLASH, PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.152mm (.006") PER SIDE
- 4. DIMENSION DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSIONS.
  INTERLEAD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.152mm (.006") PER SIDE
- 5. LEAD COPLANARITY (BOTTOM OF LEADS AFTER FORMING) SHALL BE 0.102mm (.004") MAX

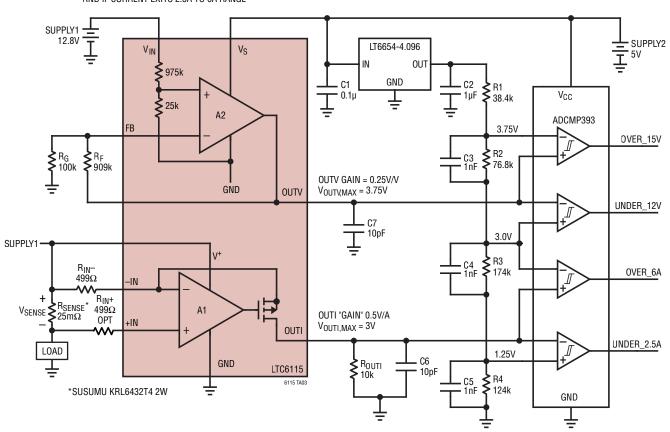
## **REVISION HISTORY**

REV	DATE	DESCRIPTION	PAGE NUMBER
Α	04/19	Changed Typical Application block diagram.	20
В	11/19	Adding Automotive Qualified Parts to Datasheet	All

## TYPICAL APPLICATION

#### **LED Headlamp Supply Monitoring with LTC6115**

65W 12.8V LED HEADLAMP MONITOR DETECTS IF VOLTAGE EXITS 12V TO 15V RANGE AND IF CURRENT EXITS 2.5A TO 6A RANGE



## **RELATED PARTS**

PART NUMBER	DESCRIPTION	COMMENTS
LT®1787/LT1787HV	Precision, Bidirectional, High Side Current Sense Amplifier	2.7V to 60V Operation, 75µV Offset, 60µA Current Draw
LTC4150	Coulomb Counter/Battery Gas Gauge	Indicates Charge Quantity and Polarity
LT6100	Gain-Selectable High Side Current Sense Amplifier	4.1V to 48V Operation, Pin-Selectable Gain: 10, 12.5, 20, 25, 40, 50V/V
LTC6101/LTC6101HV	High Voltage High Side Current Sense Amplifier	4V to 60V/5V to 100V Operations, External Resistor Set Gain, SOT23
LTC6102/LTC6102HV	Zero Drift High Side Current Sense Amplifier 4V to 60V, Gain Configurable, 8-Lead MSOP	
LTC6103	Dual High Side Precision Current Sense Amplifier	4V to 60V, Gain Configurable, 8-Lead MSOP
LTC6104	Bidirectional High Side Precision Current Sense Amplifier	4V to 60V, Gain Configurable, 8-Lead MSOP
LT6106	Low Cost, High Side Precision Current Sense Amplifier	2.7V to 36V, Gain Configurable, SOT23
ADCMP393	Quad Comparators with Known Power-Up State	2.3V to 5.5V, 26.8µA Supply, 14-Lead TSSOP/SOIC
LTC2489	Easy-Drive 2-/4-Channel ΔΣ	16-Bit, 2.7V to 5.5V Supply, 160µA Conversion 1µA Sleep
LT6654	Precision Wide Supply Low Noise Reference	V <sub>OUT</sub> +0.5V to 36V, 350µA Supply, ±10mA Source and Sink

